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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/828,492	04/21/2004	Sadami Takeoka	60188-820	5291
7590 04/06/2007 McDermott, Will & Emery 600 13th Street, N.W.			EXAMINER DICKEY, THOMAS L	
			2826	
SHORTENED STATUTOR	RY PERIOD OF RESPONSE	MAIL DATE	DELIVERY MODE	
3 MC	ONTHS	04/06/2007	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

	Application No.	Applicant(s)			
	10/828,492	TAKEOKA ET AL.			
Office Action Summary	Examiner	Art Unit			
·	Thomas L. Dickey	2826			
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply					
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).					
Status					
1)⊠ Responsive to communication(s) filed on <u>23 Ja</u>	nuary 2007.				
2a) This action is FINAL . 2b) ∑ This action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims					
4)⊠ Claim(s) <u>11-18</u> is/are pending in the application.					
4a) Of the above claim(s) <u>17 and 18</u> is/are withdrawn from consideration.					
5)⊠ Claim(s) <u>14 and 15</u> is/are allowed.					
6)⊠ Claim(s) <u>11-13 and 16</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/or election requirement.					
Application Papers					
9)☐ The specification is objected to by the Examiner.					
10)⊠ The drawing(s) filed on <u>21 April 2004</u> is/are: a)⊠ accepted or b)⊡ objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).					
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.					
Priority under 35 U.S.C. § 119					
12)⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).					
a)⊠ All b)□ Some * c)□ None of:					
1. Certified copies of the priority documents have been received.					
2. Certified copies of the priority documents have been received in Application No. 10/187,269.					
3. Copies of the certified copies of the priority documents have been received in this National Stage					
application from the International Bureau (PCT Rule 17.2(a)).					
* See the attached detailed Office action for a list of the certified copies not received.					
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Attachment(s)					
1) Notice of References Cited (PTO-892) 4) Interview Summary (PTO-413)					
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) Paper No(s)/Mail Date					
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	5) Notice of Informal Pa	atent Application (PTO-152)			
S. Potoni and Todayand Office					

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DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 01/23/2007 has been entered.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 11 and 12 are rejected under 35 U.S.C. 103(a) as being unpatentable over JARWALA ET AL. (5,673,276) in view of KOMOIKE (6,094,736) and Yamamura (5,341,096).

Jarwala et al. disclose a semiconductor device comprising a semiconductor wiring substrate 10, said semiconductor wiring substrate 10 being composed of a ceramic,

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having a wiring ("leads," not shown for the sake of clarity, note column 3 line 53) layer; a plurality of chip IPs 14 mounted on said semiconductor wiring substrate 10 by being bonded thereto; a boundary scan test circuit 16 provided in each of said chip IPs 14; scanning signal input terminals 53' and 53 connected to an internal scan chain (note column 5 lines 62-65), at least one of said scanning signal input terminals 53' and 53 being a terminal 53 specially formed separately from said boundary scan test circuit 16; wherein said internal scan chain is for an internal scan test (such as described at column 4 lines 36-47) provided in each of said chip IPs 14, and the boundary scan test circuit 16 and the internal scan chain for an internal scan test are formed so as to be capable of performing a boundary scan test and an internal scan test simultaneously with each other for testing said combinational ("combined out of constituent parts") circuit, using test data for an internal scan test which is input from outside. Note figures 3-6 and 9-12 of Jarwala et al.

Jarwala et al. do not disclose that said ceramic is semiconductor material. However, Komoike discloses a semiconductor wiring substrate 1 being composed of a semiconductor (note figure 1) on which a plurality of semiconductor chip IPs 2,4 are to be mounted; and a plurality of pieces of wiring 7 formed on the semiconductor substrate 1 to be used only for testing. Note figure 1 of Komoike. Why should one substitute the semiconductor substrate of Komoike for the ceramic substrate of Jarwala et al.? One having skill in the Multi-chip Module Art would know. A mismatch in the materials used for the substrate and the chips bonded thereon could result in a TCE (thermal

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coefficient of expansion) mismatch. When the assembly is heated, the substrate and chips could expand at different rates, resulting in potentially damaging stress between the constituent parts. This problem is often discussed in the art, for example at column 1 lines 17-40 of Canestaro et al. 4,728,751. Therefore, it would have been obvious to a person having skill in the art to replace the ceramic material of Jarwala et al.'s substrate with the semiconductor material such as taught by Komoike in order to match the material, and thus the CTE, of the chip IPs to thus avoid possible damage due to thermal stress.

Further, Jarwala et al. does not disclose (at least in so many words. Given that Jarwala et al. discloses a test circuit it would make sense if Jarwala et al. also disclosed something to test, but Jarwala et al. leaves the test object to the reader's imagination) that said chip IPs each include a logic circuit which is a test object (DUT, which is "slang" for Device Under Test) to be tested by said internal scan test. However, Yamamura discloses a semiconductor device very similar to Jarwala et al.'s in that it includes a boundary scan test circuit 7b provided in each of a group of chip IPs 1A, 1B; and an internal scan chain 7a for an internal scan test, said scan chain being formed in each of said chip IPs 1A, 1B and capable of operating simultaneously with said boundary scan test circuit 7b. Note figures 2-5, 9, 12A, column 2 lines 11-21, and column 5 lines 11-57 of Yamamura. Yamamura also discloses a "logic circuit which is a test object (DUT)" in the form of testable LSI's (large scale integrated circuits in each of said chip IPs 1A, 1B, to be tested by Yamamura's internal scan test. Therefore, it would

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have been obvious to a person having skill in the art to augment Jarwala et al.'s semiconductor device with the logic circuit which is a test object (DUT, which is "slang" for Device Under Test) to be tested by said internal scan test such as taught by Yamamura in order to give the scan test something to test, to thus a valuable use for the scan test.

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Allowable Subject Matter

3. Claims 14 and 15 are allowed over the art of record.

Response to Arguments

4. Applicant's arguments with respect to claims 11,12,13, and 16 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thomas L. Dickey whose telephone number is 571-272-1913. The examiner can normally be reached on Monday-Thursday 8-6.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Sue Purvis can be reached on 571-272-1236. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Thomas L. Dickey
Primary Patent Examiner
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